

Title (en)

USE OF TOPICAL COMPOSITIONS FOR THE CONTROL OF MICROBIAL DISEASES OF THE NAIL

Title (de)

VERWENDUNG VON TOPISCHEN ZUSAMMENSETZUNGEN ZUR KONTROLLE VON MIKROBIELLEN ERKRANKUNGEN DER NÄGEL

Title (fr)

UTILISATION DE COMPOSITIONS TOPIQUES DANS LA LUTTE CONTRE DES MALADIES MICROBIENNES DE L'ONGLE

Publication

**EP 1494688 A4 20070704 (EN)**

Application

**EP 03746769 A 20030417**

Priority

- AU 0300471 W 20030417
- AU PS179302 A 20020417

Abstract (en)

[origin: WO03088983A1] A method of treating or preventing a microbial disease of a subject's nail, such as onychomycosis, the method comprising the step of topically administering to the nail an effective amount of copper silicate.

IPC 1-7

**A61K 33/38**; **A61P 31/00**

IPC 8 full level

**A61K 45/00** (2006.01); **A61K 8/25** (2006.01); **A61K 33/34** (2006.01); **A61K 33/38** (2006.01); **A61P 31/00** (2006.01); **A61P 31/02** (2006.01); **A61P 31/04** (2006.01); **A61P 31/10** (2006.01); **A61Q 3/00** (2006.01)

CPC (source: EP)

**A61K 8/25** (2013.01); **A61K 33/34** (2013.01); **A61P 31/00** (2017.12); **A61P 31/02** (2017.12); **A61P 31/04** (2017.12); **A61P 31/10** (2017.12); **A61Q 3/00** (2013.01)

Citation (search report)

- [A] WO 9307754 A1 19930429 - SHEEN BIOTECHNOLOGY PTY LTD [AU], et al
- [A] US 3836633 A 19740917 - BESCHKE H
- See references of WO 03088983A1

Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PT RO SE SI SK TR

Designated extension state (EPC)

AL LT LV MK

DOCDB simple family (publication)

**WO 03088983 A1 20031030**; AP 1777 A 20070903; AP 2004003163 A0 20041231; AU 2003227095 A1 20031103; AU 2003227095 B2 20070531; AU PS179302 A0 20020530; BR 0309266 A 20050301; CA 2482439 A1 20031030; CN 1649605 A 20050803; EA 200401395 A1 20050630; EP 1494688 A1 20050112; EP 1494688 A4 20070704; HK 1079983 A1 20060421; IL 164557 A0 20051218; JP 2005523317 A 20050804; MX PA04010131 A 20050608; NZ 535903 A 20050624; OA 12808 A 20060711; ZA 200408372 B 20071031

DOCDB simple family (application)

**AU 0300471 W 20030417**; AP 2004003163 A 20030417; AU 2003227095 A 20030417; AU PS179302 A 20020417; BR 0309266 A 20030417; CA 2482439 A 20030417; CN 03809987 A 20030417; EA 200401395 A 20030417; EP 03746769 A 20030417; HK 06100021 A 20060103; IL 16455704 A 20041013; JP 2003585735 A 20030417; MX PA04010131 A 20030417; NZ 53590303 A 20030417; OA 1200400283 A 20030417; ZA 200408372 A 20030417